PSP Model Equation Extension for Statistical Estimation of Leakage Current in Nanometer CMOS Technologies Considering Process Variations

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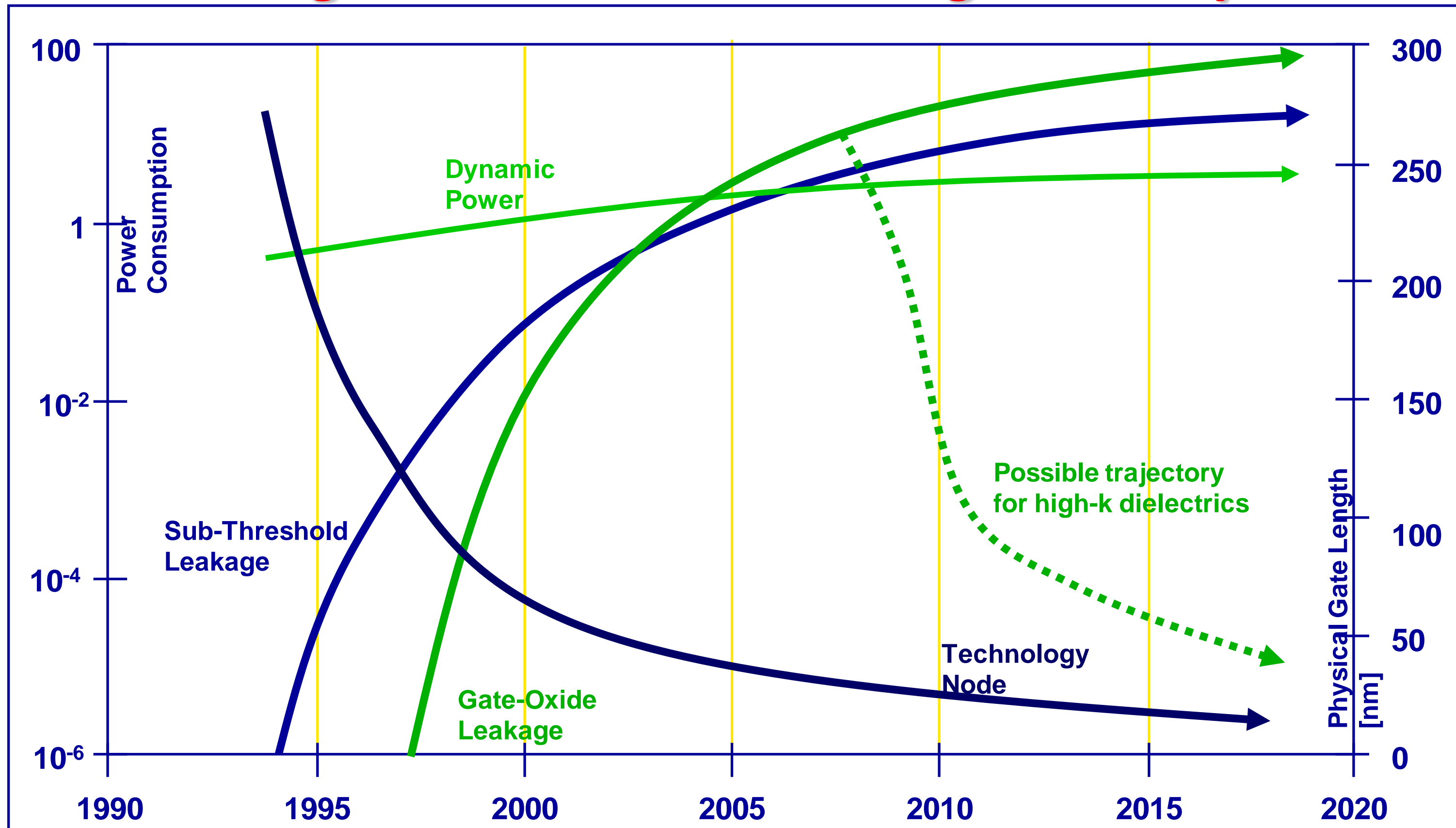
Leakage trends

Subthreshold and gate **leakage dramatically increase** with each successive technology node

=> Leakage currents cannot be neglected anymore



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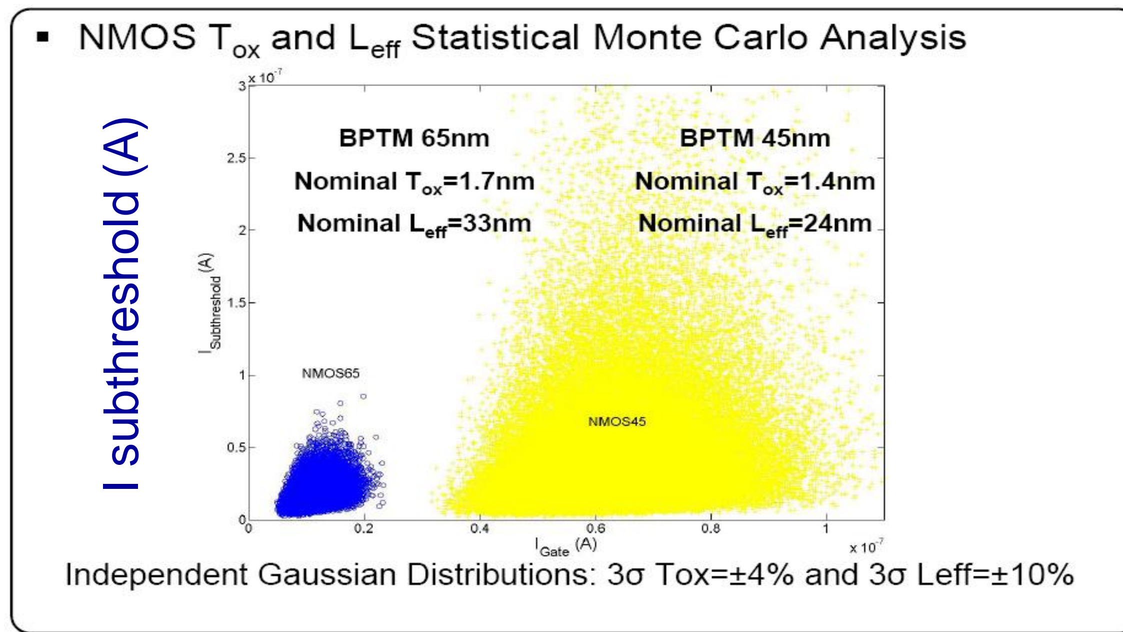
Computation Time

Direct **Monte-Carlo** (MC) simulation is computationally **too expensive** to estimate the statistical leakage distribution of **complex** circuits

=> MC simulations flow not applicable to nowadays ICs design flow



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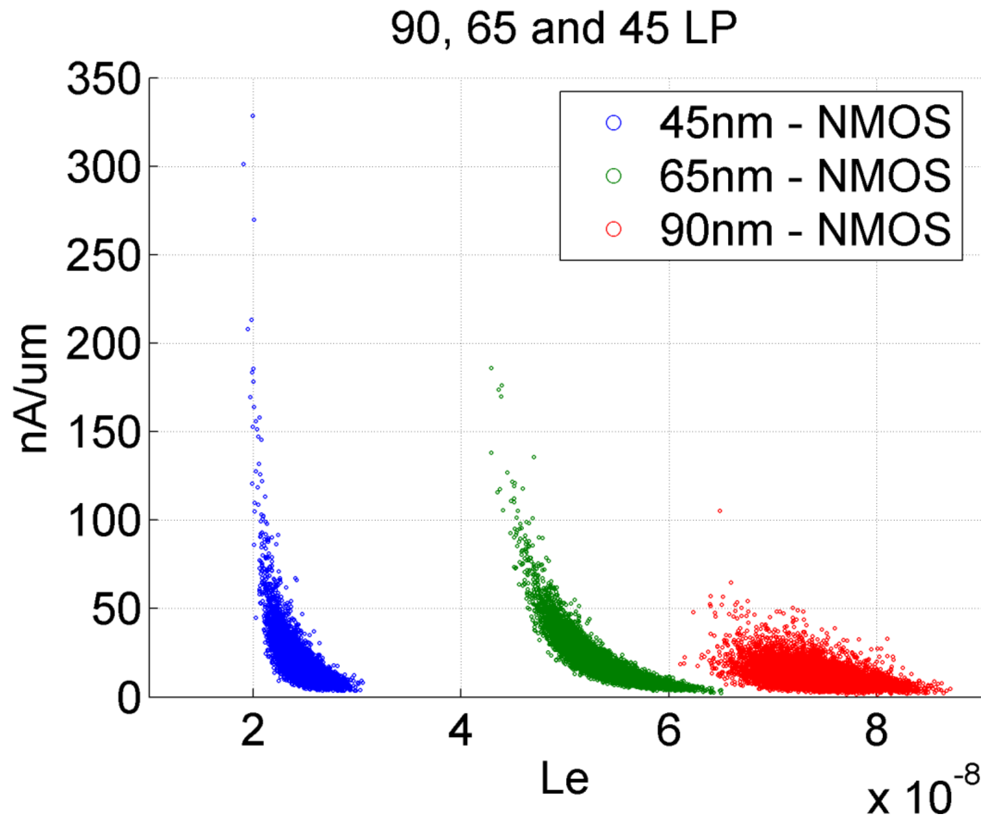
State of the art **statistical leakage analysis** methodology are based on:

- approximated PSP or BSIM models
- new transistor models

Variability Issues

Process parameter variations make devices and interconnects appear as **statistical variables**

=> Classic corner based approach is too pessimistic



Outline

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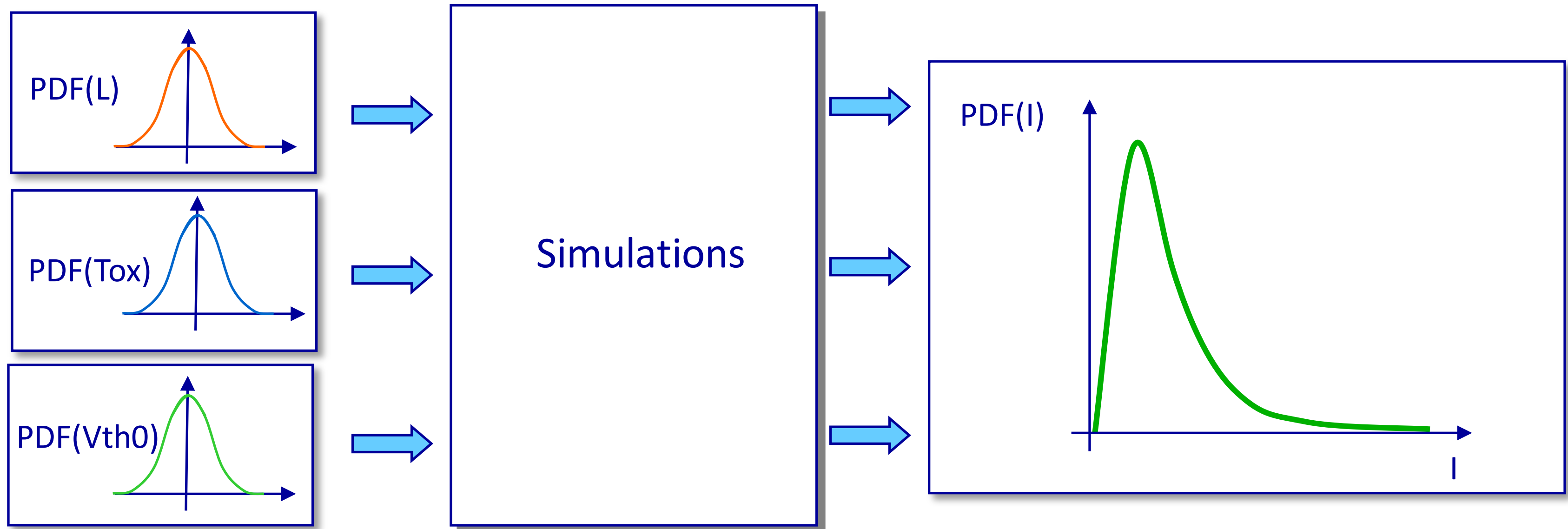
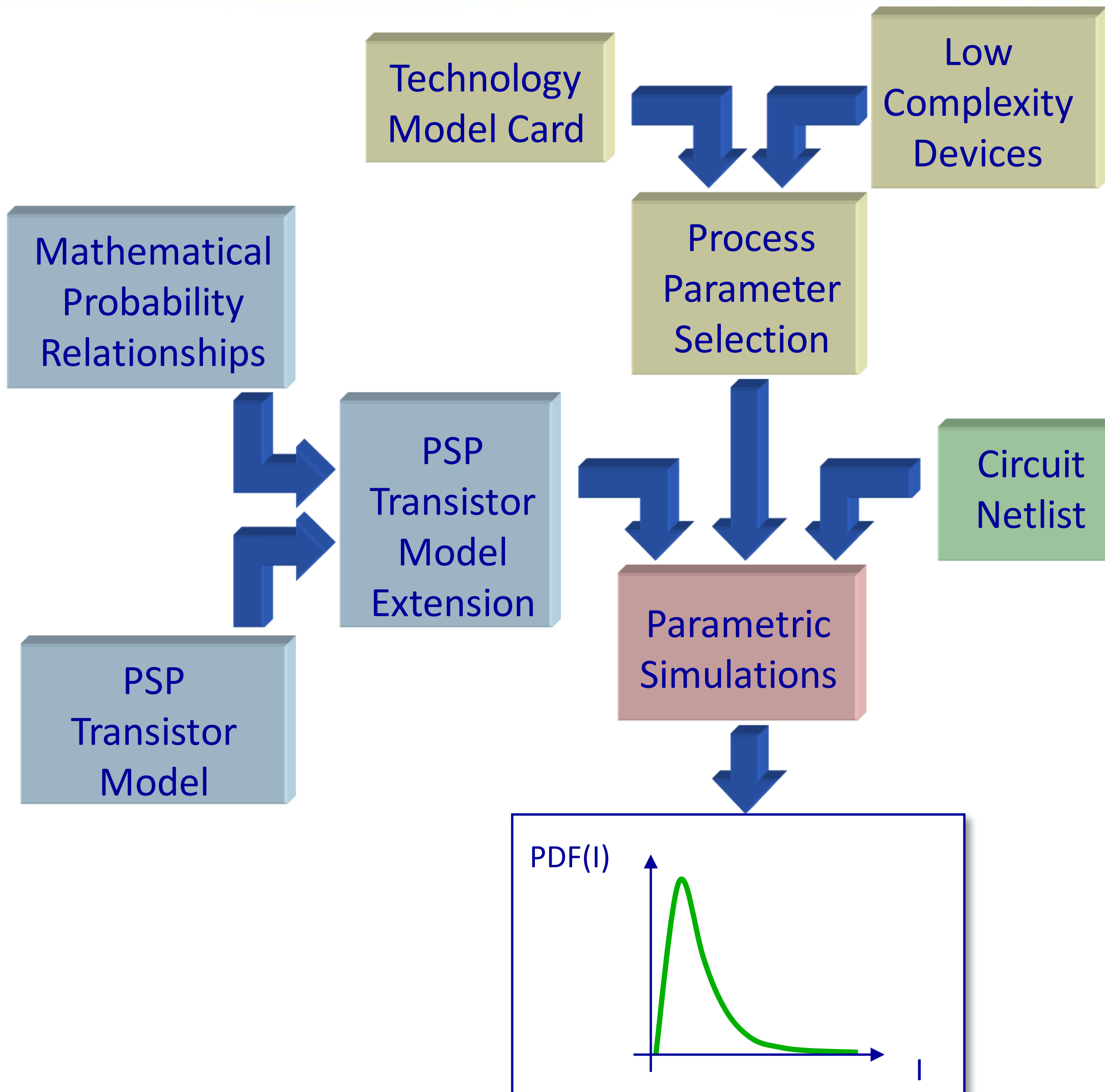
- Objectives of this work
- General statistical leakage analysis overview
- Process parameter selection
- PSP model extension: mathematical background
- PSP model extension: implementation
- Simulation Strategy
- Results
- Conclusions

Objective of this work

Compute the **analytical expression** of the Probability Density Function (PDF) of leakage current considering the statistical variations of the **technological parameters**



General methodology overview

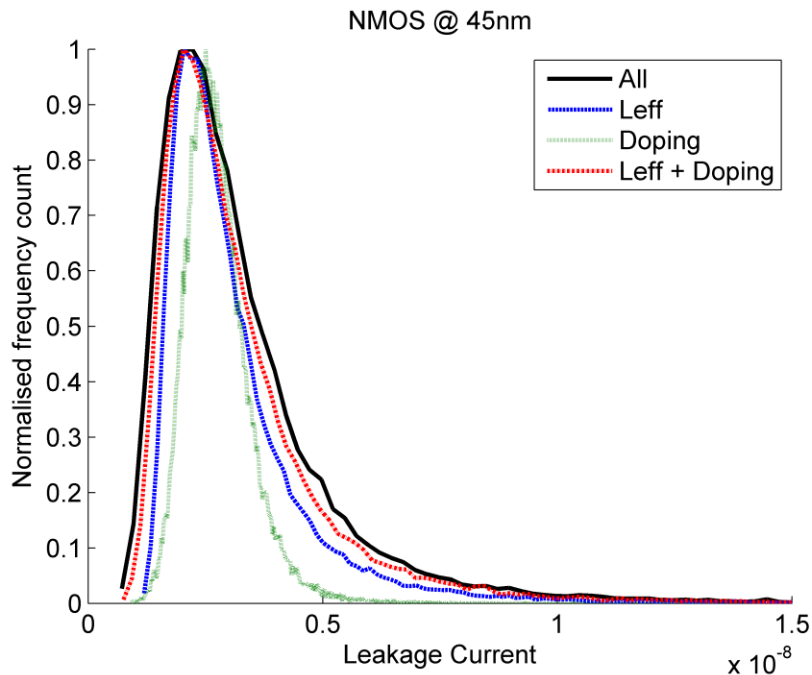


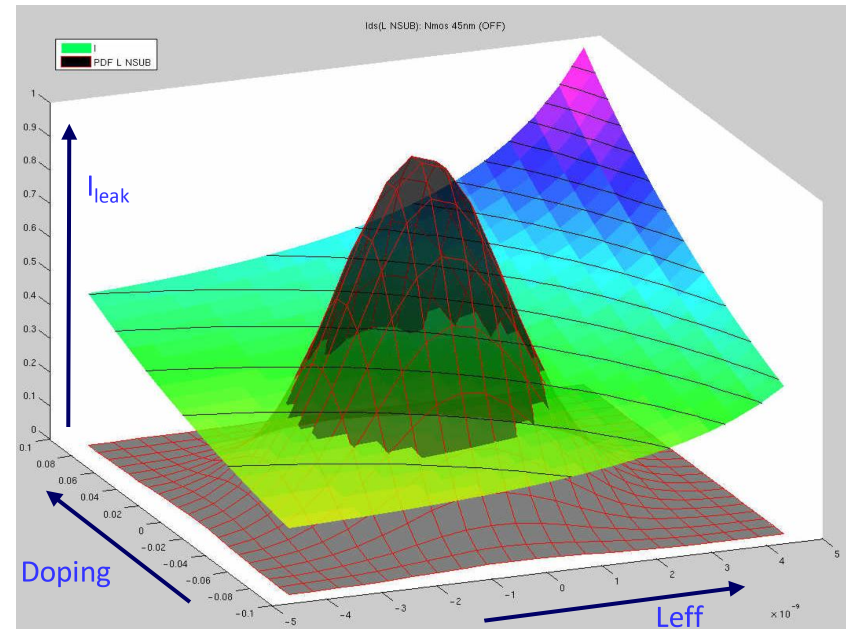
Process Parameter Selection

Each leakage contribution in a CMOS device depends on **more than one** process parameter

The impact of process parameter variations on the leakage PDF **is different** for each technology node

In 45nm to estimate the PDF of the leakage current it is necessary to consider at least the **variations of the gate length** and the **variations of the dopant concentration**





PSP Model Extension: Mathematical Background (1)

Considering L_{gate} as varying process parameter, we need:

Function **h(L_{gate})** => $I_{leak}(L_{gate})$

Function **h'(L_{gate})** => First derivative of $I_{leak}(L_{gate})$

Function **g (I_{leak})** => $L_{gate}(I_{leak})$ $=f^{-1}(h)$

Function **PDF(L_{gate})** => f_x (Generally Gaussian)

We get:

$$PDF(I_{leak}) = f_y = \frac{f_x(g(I_{leak}))}{h'(L_{gate})}$$

Problem:

the function **Ileak(Lgate)** used in PSP model **is not** analytically invertible!

Solution:

use the **intrinsic** calculations of SPICE simulator engine to express the PDF(I) directly as **function of Lgate**

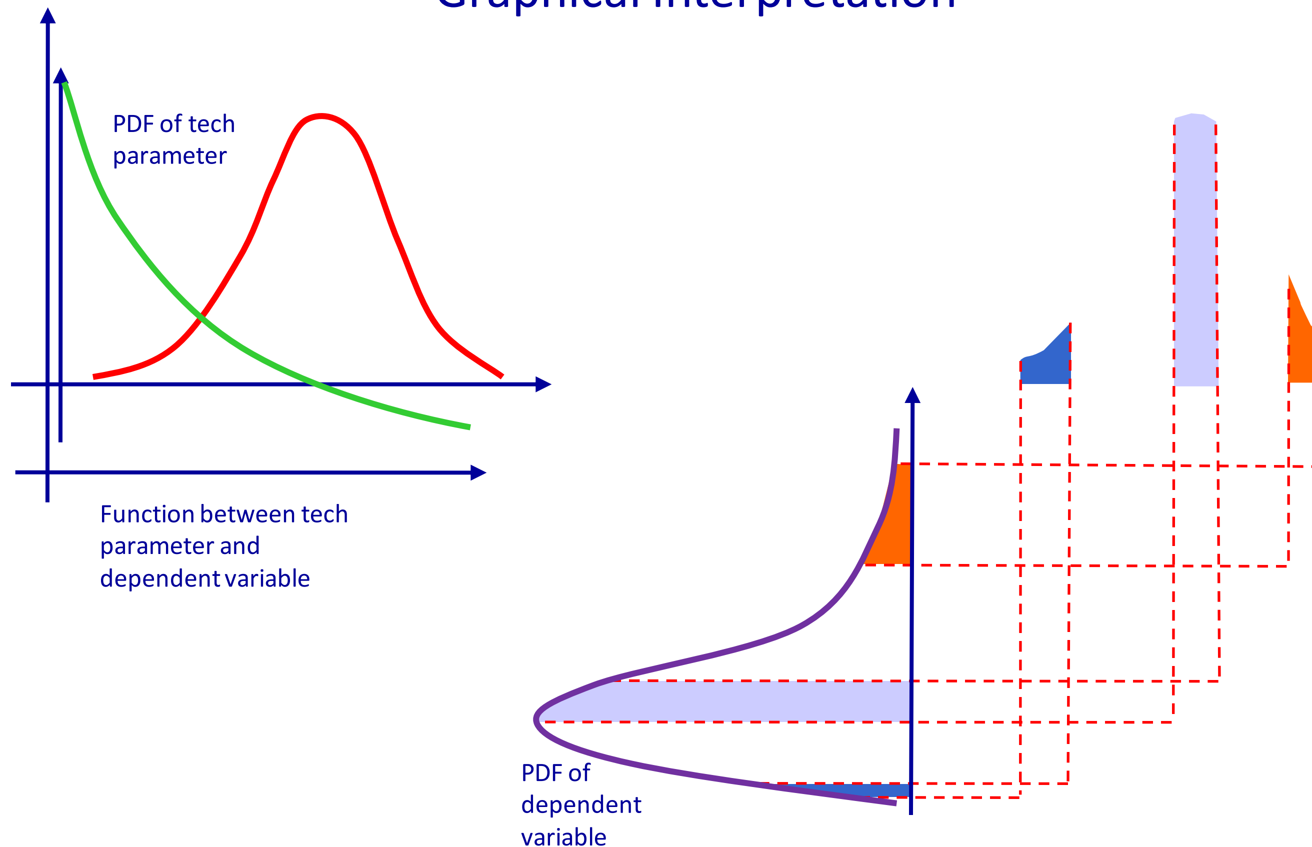
$$PDF(I_{leak}) = f_y = \frac{f_x(L_{gate})}{h'(L_{gate})}$$

PSP Model Extension: Mathematical Background (2)

Mathematical expression

$$PDF(I) = \frac{PDF(TechParam)}{\frac{dI}{dTechParam}}$$

Graphical Interpretation



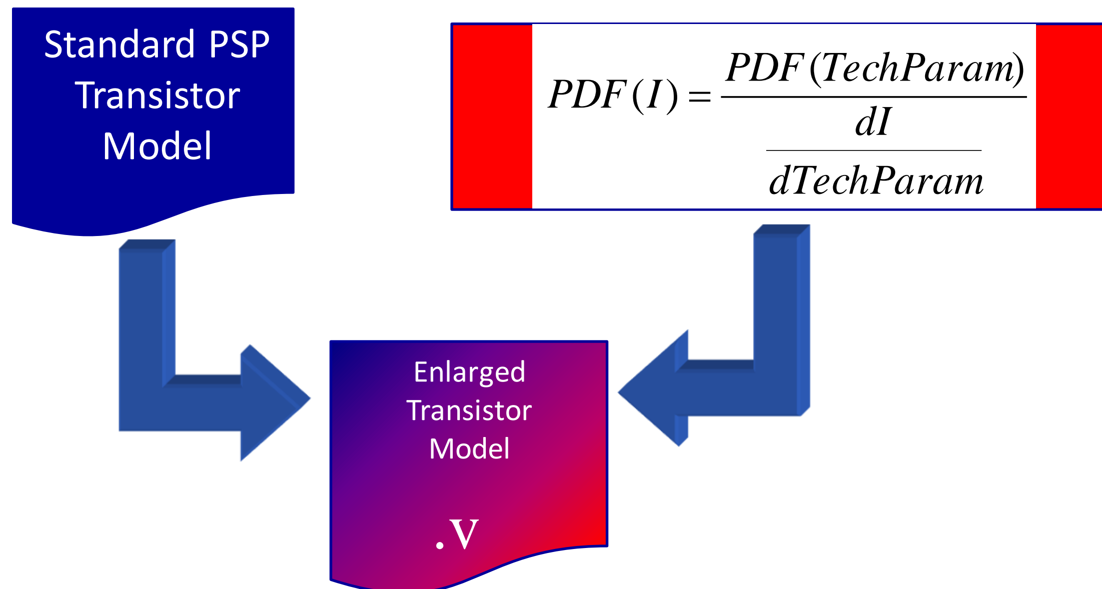
PSP Model Extension: implementation (1)

In the current implementation is used the PSP model coded in **verilog-A**

In the extended PSP transistor model **have been included**:

- The **derivatives** of each leakage current respect to the selected process parameters
- The **PDFs** of the selected process parameter (defined in the technology model card)

All the other equations remain **untouched**



PSP Model Extension: implementation (2)

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Two virtual pins are added to the transistor model in order to have directly the PDF value of the leakage current as SPICE **simulation output**

Transistor node definition:

```
...
   inout      D, G, S, B, PDF_I_LEFF, PDF_I_LEFF;
   electrical D;
   electrical G;
   electrical S;
   electrical B;
   electrical PDF_I_LEFF;
   electrical PDF_I_NSUB;
...
```

The **PDFs equations** of gate length and dopant concentration (defined in the technology model cards) are coded in the **Verilog-A** PSP model files

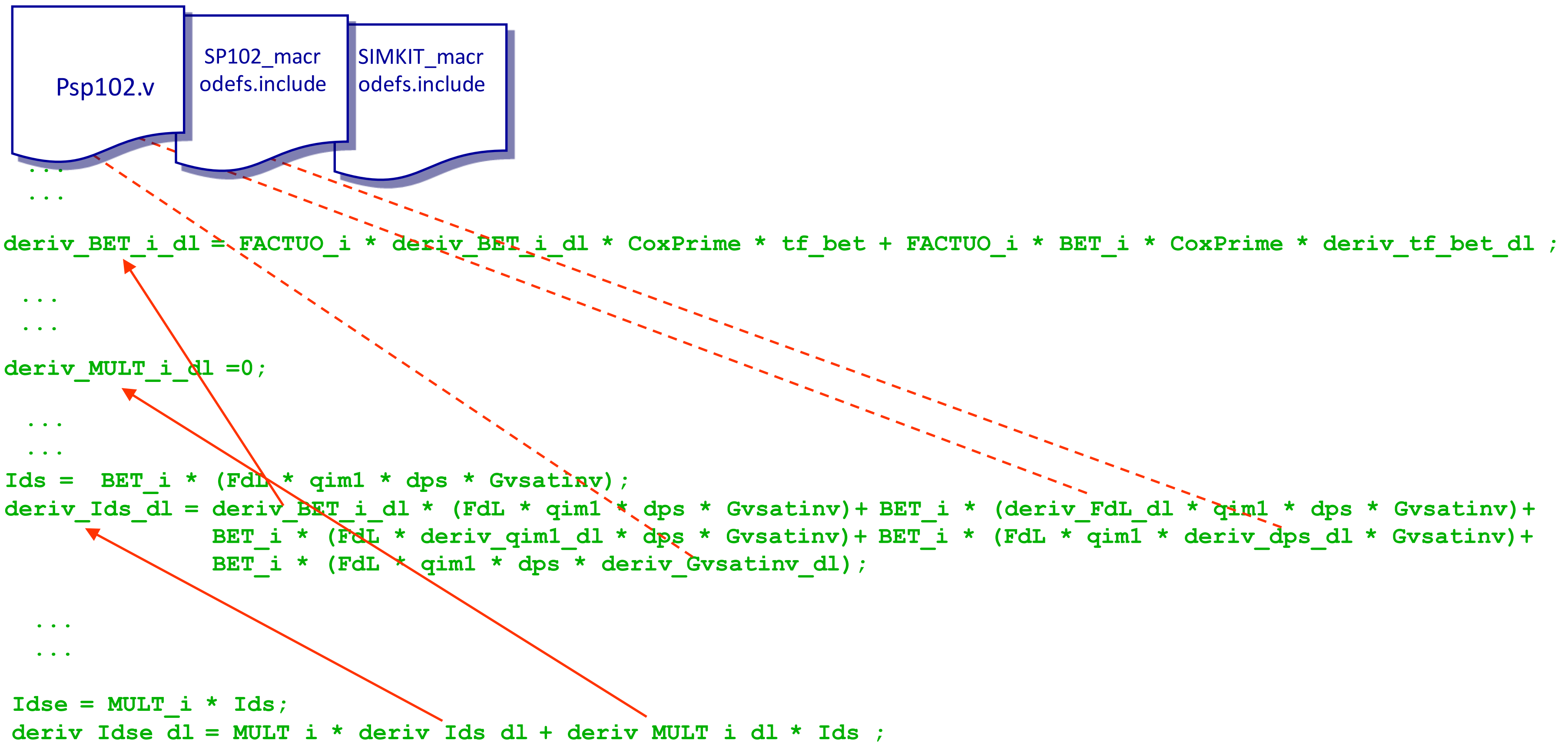
Example of PDF of gate length and doping concentration assuming Gaussian distributions:

```
...
PDF_L = (1/(sigma_dl *sqrt(2*`PI)))*exp(-(pow((LVARO-mu_dl),2))/(2*sigma_dl*sigma_dl));
...
PDF_NSUB = (1/(sigma_dnsub *sqrt(2*`PI)))*exp(-(pow((NSUBO-mu_dnsub),2))/(2*sigma_dnsub*sigma_dnsub));
...
```

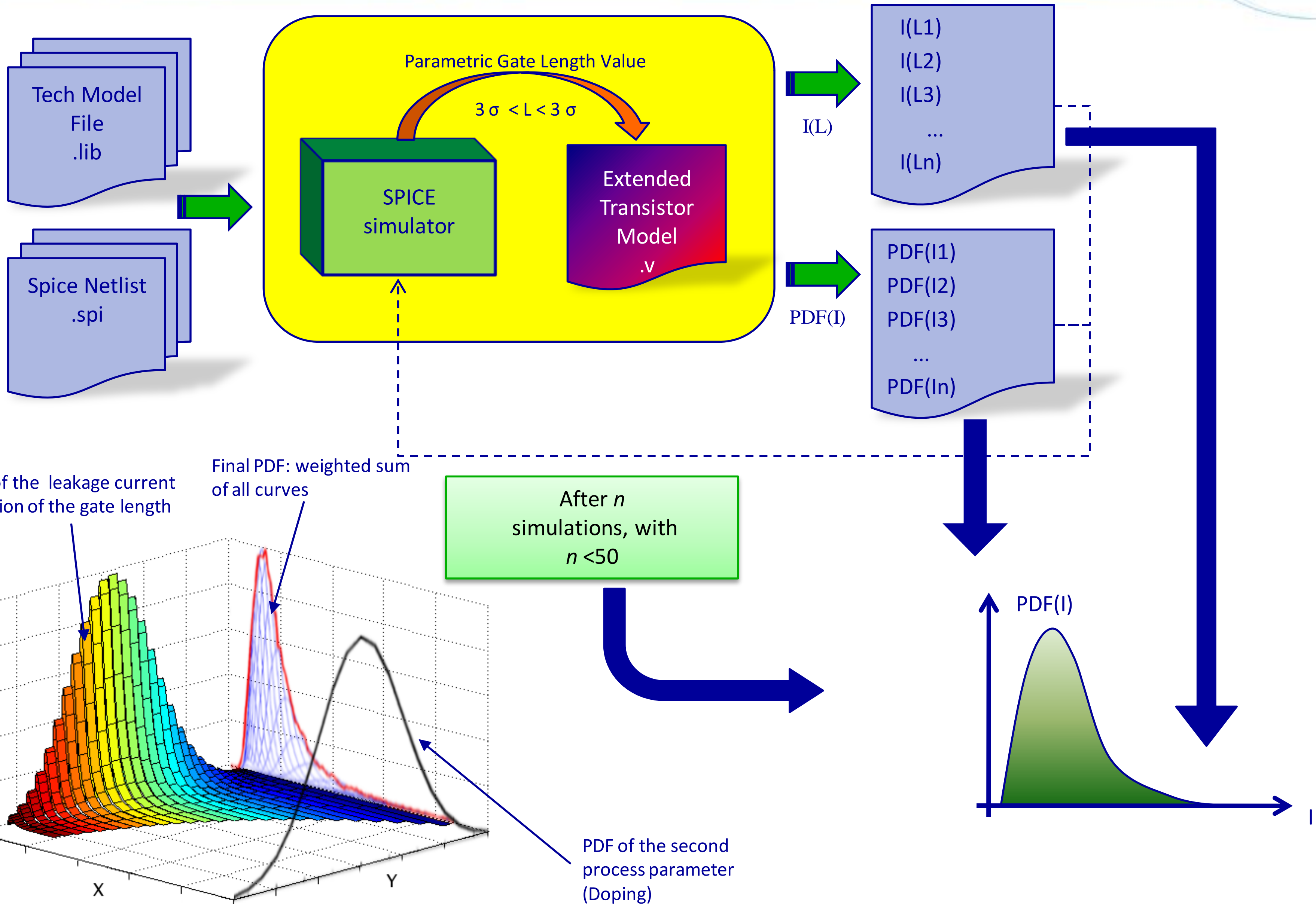
PSP Model Extension: implementation (3)

Analytical derivative for each leakage current, respect to the gate length and dopant concentration, are coded in the **Verilog-A** PSP model files

Example of Ids derivation respect to the variations in gate length



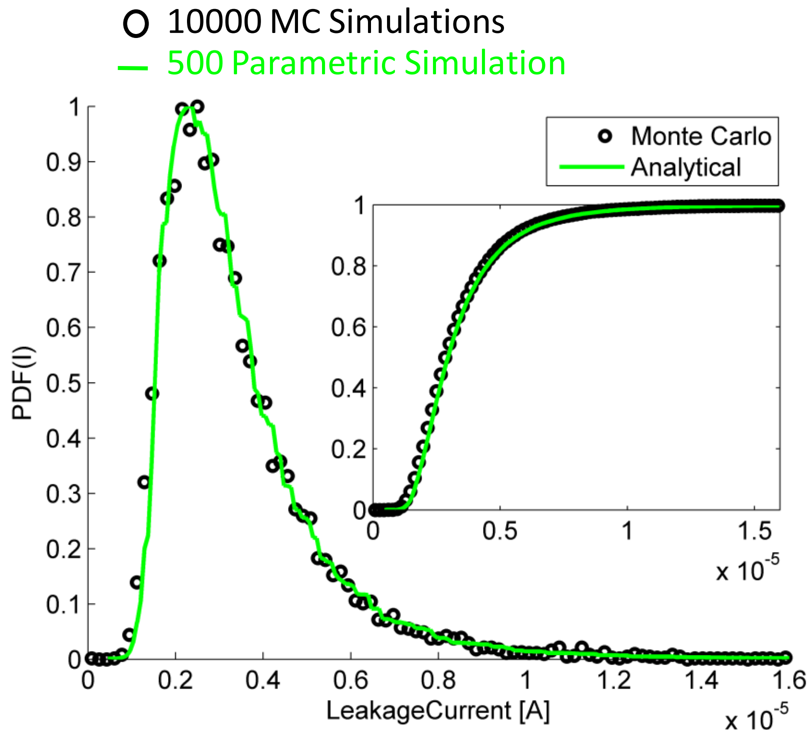
Simulation Strategy



Results

At **45nm** technology node, **comparisons** with extensive Monte-Carlo on simulations show the **accuracy** and **saving** (in term of computational time) of the proposed approach

Simple two logic gate statistical leakage example (@45 nm):



Medium complexity logic circuits (ISCAS):

Circuit	Mu (MC)	Mu (PSPE)	E%	SD (MC)	SD (PSPE)	E%
C432	3,4e-06	3,5e-06	2,7	2,0e-06	2,0e-06	0,6
C499	5,3e-06	5,5e-06	3,1	3,0e-06	3,0e-06	1,1
C1908	7,0e-04	7,1e-04	0,6	8,6e-05	7,8e-05	9,8
C2670	1,2e-04	1,2e-04	1,1	1,7e-05	1,6e-05	5,6
C3540	3,9e-04	3,9e-04	0,7	5,0e-05	4,6e-05	7,8
C5315	1,2e-03	1,2e-03	0,6	1,5e-04	1,4e-04	7,8
C6288	4,4e-05	4,5e-05	2,5	2,7e-05	2,5e-05	4,8
C7552	6,9e-04	6,9e-04	0,9	8,9e-05	8,2e-05	8,2
Average			**1.5**			**5.7**

Accuracy can be easily **compromised** with **simulation time** selecting the appropriate number of parametric simulations

Conclusions

The proposed methodology:

- Predict median, standard deviation, and the shape of the PDF of the leakage current
- Use the complete PSP transistor model (no need of extra empirical fitting parameters)
- Consider variations of several process parameters at the same time
- Currently is implemented in verilog-A
- Has been verified by means of extensive Monte-Carlo simulations @ 45nm tech node

Thank You!

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